

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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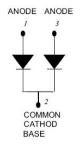
203CNQ080/203CNQ100 SCHOTTKY RECTIFIER



Features

- 175°C T_J operation
- Center tap module
- High purity, high temperature epoxy encapsulation for
- enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- · High current switching power supply
- Plating power supply
- · Free-Wheeling diodes
- Reverse battery protection
- Converters
- UPS System
- Welding

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | | Units |
|-----------------------------------------------------------------|----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-----------------|-----------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage | V _{RRM} | - | 80 | 203CNQ080 | V |
| DC Blocking Voltage | $egin{array}{c} V_{RWM} \ V_{R} \end{array}$ | | 100 | 203CNQ100 | V |
| Average Rectified Forward Current | I _{F(AV)} | 50% duty cycle @T _C =121°C, | 100(Per Leg) | | A |
| | | rectangular wave form | 200(Per Device) | | |
| Peak One Cycle Non-Repetitive Surge Current (Per Leg) | I _{FSM} | 8.3 ms, half Sine pulse | 2520 | | Α |
| Non-Repetitive Avalanche Energy(Peg Leg) | E _{AS} | TJ=25℃,I _{AS} =1A,L=30mH | 15 | | mJ |
| Repetitive Avalanche Current (Peg Leg) | I _{AR} | Current decaying linearly to zero in 1 µsec Frequency limited by T _J max. V _A =1.5×V _R typical | | 1 | А |

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com
 sales@ smc-diodes.com









Electrical Characteristics:

| Characteristics | Symbol | Condition | Тур. | Max. | Units |
|--------------------------------|-----------------|----------------------------------------------------------------------------------|-----------|--------------|-------|
| Forward Voltage Drop(Per Leg)* | V _{F1} | @ 100A, Pulse, T _J = 25 °C @ 200A, Pulse, T _J = 25 °C | 0.79 - | 0.86 1.03 | V |
| | V _{F2} | @ 100A, Pulse, T _J = 125 °C @ 200A, Pulse, T _J = 125 °C | 0.61 - | 0.70 0.84 | ٧ |
| Reverse Current(Per Leg)* | I _{R1} | $@V_R = \text{rated } V_{R,} T_J = 25 ^{\circ}\text{C}$ | 0.001 | 3 | mA |
| | I _{R2} | $@V_R = \text{rated } V_{R,} T_J = 125 ^{\circ}\text{C}$ | 0.8 | 40 | mA |
| Junction Capacitance(Per leg) | Ст | $@V_R = 5V, T_C = 25 °C$ $f_{SIG} = 1MHz$ | 2400 | 2650 | pF |
| Voltage Rate of Change | dv/dt | - | - | 10,000 | V/μs |

^{*} Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:

| Characteristics | Symbol | Condition | Specific | Units | |
|----------------------------------------------------------|-------------------|--------------------------------------|--------------------|--------------------|---------|
| Junction Temperature | TJ | - | -55 to +175 | | °C |
| Storage Temperature | T _{stg} | - | -55 to +175 | | °C |
| Typical Thermal Resistance Junction to Case(Per leg) | $R_{	heta JC}$ | DC operation | 0.50 | | °C/W |
| Typical Thermal Resistance Junction to Case(Per package) | $R_{	heta JC}$ | DC operation | 0.25 | | °C/W |
| Typical Thermal Resistance, case to Heat Sink | $R_{	heta cs}$ | Mounting surface, smooth and greased | 0.10 | | °C/W |
| Mounting Torque | TM | - | Mounting Torque | 24(min) 35(max) | - Kg-cm |
| | | | Terminal Torque | 35(min) 46(max) | |
| Approximate Weight | wt | - | 79 | | g |
| Case Style | PRM4 Non-Isolated | | | | |

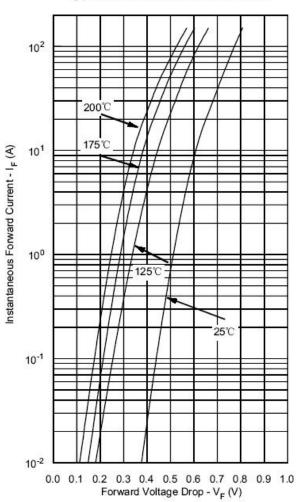




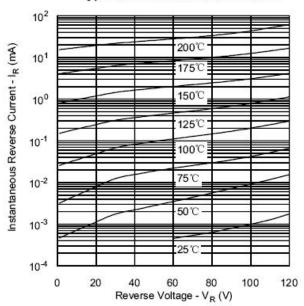


Ratings and Characteristics Curves

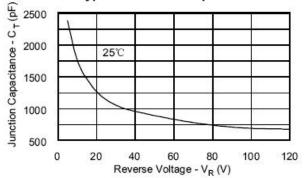
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance



[•] China - Germany - Korea - Singapore - United States •

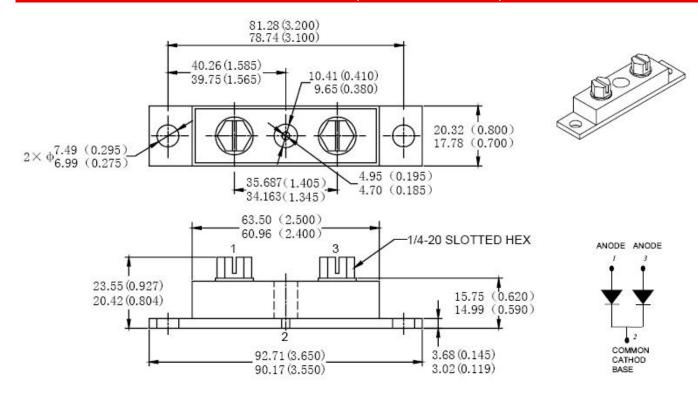




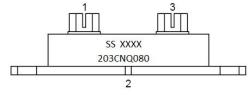




Mechanical Dimensions PRM4 Non-Isolated(Millimeters/Inches)



Marking Diagram



Where XXXX is YYWW

203CNQ080 = Part name SS = SS YY = Year WW = Week

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information

| Device | Package | Shipping |
|---------------|----------------------------------|-----------|
| 203CNQ SERIES | PRM4(Non- Isolated) (Pb-Free) | 9 pcs/box |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.









DISCLAIMER:

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